

NUF4403MN

4 Line EMI Filter with ESD Protection

This device is a 4 line EMI filter array for wireless applications. The NUF4403MN provides greater than -35 dB attenuation at frequencies from 800 MHz to 2.2 GHz. It also offers ESD protection—clamping transients from static discharges. ESD protection is provided across all capacitors.

Features

- EMI Filtering and ESD Protection
- Integration of 20 Discrete Components
- Compliance with IEC61000-4-2 (Level 4)
 - 18 kV (Contact)
 - 30 kV (Air)
- DFN Package, 1.6 x 1.6 mm
- Moisture Sensitivity Level 1
- ESD Ratings: Machine Model = C
Human Body Model = 3B
- This is a Pb-Free Device*

Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Integrated Solution Offers Cost and Space Savings
- Reduces Parasitic Inductances Which Offer a More “Ideal” Low Pass Filter Response
- Integrated Solution Improves System Reliability

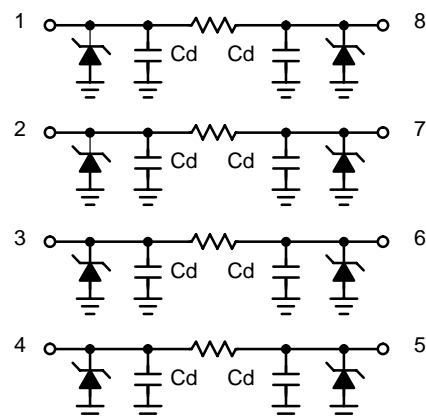
Applications

- EMI Filtering and ESD Protection for Data Lines
- Wireless Phones
- Handheld Products
- Notebook Computers
- LCD Displays

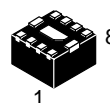


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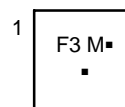


(Top View)



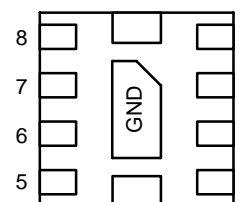
**DFN8
CASE 506AK**

MARKING DIAGRAM



F3 = Specific Device Code
M = Date Code
▪ = Pb-Free Package
(Note: Microdot may be in either location)

PIN CONNECTIONS



(Bottom View)

ORDERING INFORMATION

Device	Package	Shipping†
NUF4403MNT1G	DFN8 (Pb-Free)	3000 / Tape & Reel

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NUF4403MN

MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
ESD Discharge IEC61000-4-2 Air Discharge Contact Discharge	V_{PP}	30 18	kV
Operating Temperature Range	T_{OP}	-40 to 85	°C
Storage Temperature Range	T_{STG}	-55 to 150	°C
Maximum Lead Temperature for Soldering Purposes (1.8 in from case for 10 seconds)	T_L	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Maximum Reverse Working Voltage	V_{RWM}				5.0	V
Breakdown Voltage	V_{BR}	$I_R = 1.0 \text{ mA}$	6.0	7.0	8.0	V
Leakage Current	I_R	$V_{RWM} = 3.3 \text{ V}$			100	nA
Resistance	R_A		85	100	115	Ω
Capacitance (Notes 1 and 2)	C_d		15	17	20	pF
Cut-Off Frequency (Note 3)	f_{3dB}	Above this frequency, appreciable attenuation occurs		105		MHz

1. Measured at 25°C , $V_R = 2.5 \text{ V}$, $f = 1.0 \text{ MHz}$.
2. Total Line Capacitance is 2 times the Diode Capacitance (C_d).
3. 50Ω source and 50Ω load termination.

TYPICAL PERFORMANCE CURVES ($T_A = 25^\circ\text{C}$ unless otherwise specified)

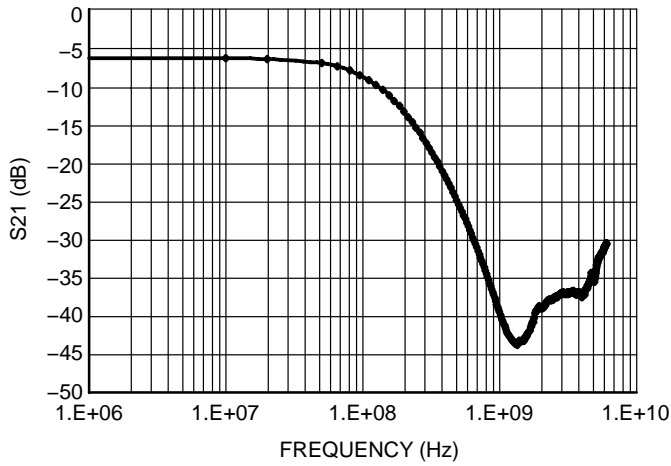


Figure 1. Insertion Loss Characteristic (S21 Measurement)

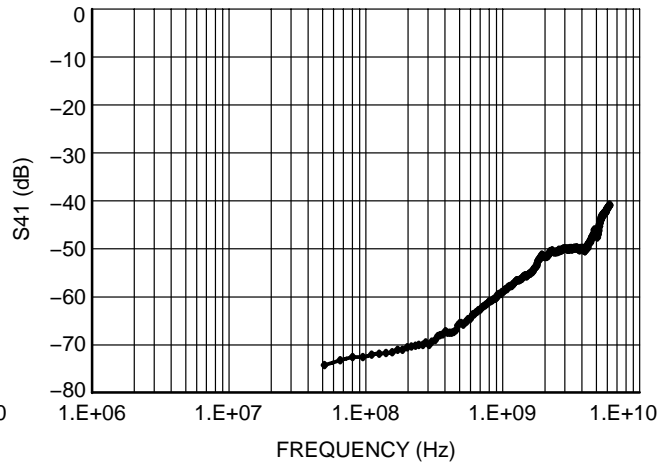


Figure 2. Analog Crosstalk Curve (S41 Measurement)

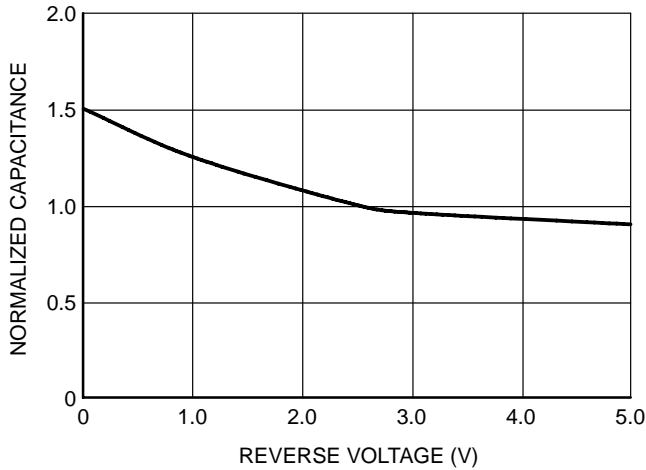


Figure 3. Typical Capacitance vs. Reverse Biased Voltage (Normalized Capacitance C_d at 2.5 V)

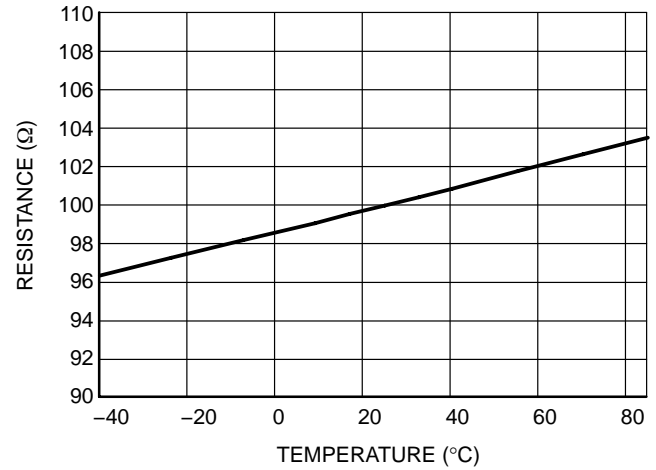
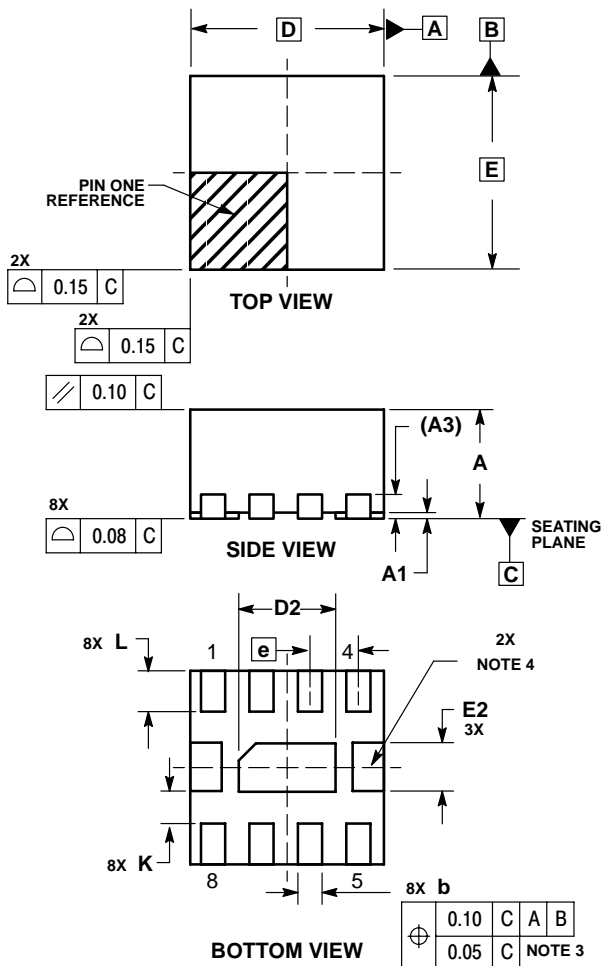


Figure 4. Typical Resistance over Temperature

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PACKAGE DIMENSIONS

DFN8
CASE 506AK-01
ISSUE C

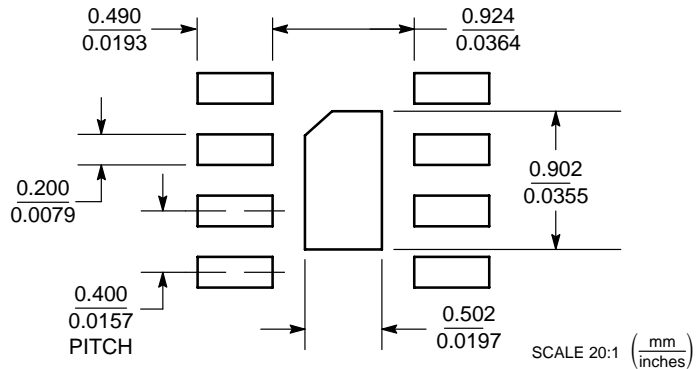


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
4. EXPOSED PADS CONNECTED TO DIE FLAG. USED AS TEST CONTACTS.

MILLIMETERS		
DIM	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.20	REF
b	0.15	0.25
D	1.60	BSC
D2	0.70	0.90
E	1.60	BSC
E2	0.30	0.50
e	0.40	BSC
K	0.20	---
L	0.20	0.40

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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NUF4403MN/D



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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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